muRata

Reference Specification

DEH Series

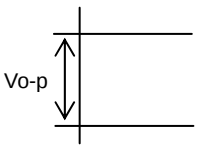
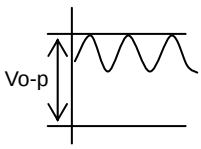
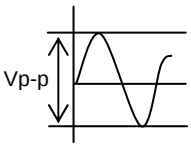
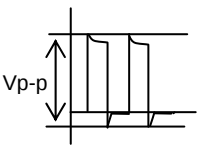
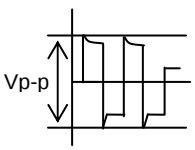
High Temperature Low Loss Lead Type Disc Ceramic Capacitors of class 2 for General Purpose

Product specifications in this catalog are as of Dec. 2017, and are subject to change or obsolescence without notice.
Please consult the approval sheet before ordering.Please read rating and Cautions first.

⚠ CAUTION

1. OPERATING VOLTAGE

When DC-rated capacitors are to be used in AC or ripple current circuits, be sure to maintain the Vp-p value of the applied voltage or the Vo-p which contains DC bias within the rated voltage range.
When the voltage is started to apply to the circuit or it is stopped applying, the irregular voltage may be generated for a transit period because of resonance or switching. Be sure to use a capacitor within rated voltage containing these irregular voltage.
When DC-rated capacitors are to be used in input circuits from commercial power source (AC filter), be sure to use Safety Recognized Capacitors because various regulations on withstand voltage or impulse withstand established for each equipment should be taken into considerations.

Voltage	DC Voltage	DC+AC Voltage	AC Voltage	Pulse Voltage(1)	Pulse Voltage(2)
Positional Measurement					

2. OPERATING TEMPERATURE AND SELF-GENERATED HEAT

Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself.
When the capacitor is used in a high-frequency current, pulse current or the like, it may have the self-generated heat due to dielectric-loss. The allowable frequency should be in less than 300kHz in sine wave. Applied voltage should be the load such as self-generated heat is within 20 °C on the condition of atmosphere temperature 25 °C. When measuring, use a thermocouple of small thermal capacity-K of ϕ0.1mm and be in the condition where capacitor is not affected by radiant heat of other components and wind of surroundings. (Never attempt to perform measurement with the cooling fan running. Otherwise, accurate measurement cannot be ensured.)

3. FAIL-SAFE

When capacitor would be broken, failure may result in a short circuit. Be sure to provide an appropriate fail-safe function like a fuse on your product if failure would follow an electric shock, fire or fume.

4. LOAD REDUCTION AND SELF-GENERATED HEAT DURING APPLICATION OF HIGH-FREQUENCY AND HIGH-VOLTAGE

Since the heat generated by the low-dissipation capacitor itself is low, its allowable power is much higher than the general B characteristic. However, in case such an applied load that the self-heating temperature is 20 °C at the rated voltage, the allowable power may be exceeded.

Therefore, when using the low-dissipation capacitors in a high-frequency and high-voltage circuit with a frequency of 1kHz or higher, make sure that the Vp-p values including the DC bias, do not exceed the applied voltage value specified in Table 1. Also make sure that the self-heating temperature (the difference between the capacitor's surface temperature and the capacitor's ambient temperature) at an ambient temperature of 25 °C does not exceed the value specified in Table 1.

As shown in Fig. 2, the self-heating temperature depends on the ambient temperature. Therefore, if you are not able to set the ambient temperature to approximately 25 °C, please contact our sales representatives or product engineers.

<Table 1> Allowable Conditions at High-frequency

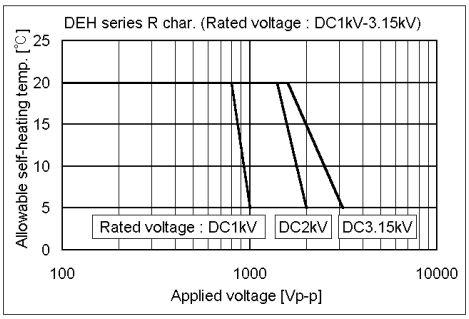
Temp. Char.	DC Rated Voltage	Allowable Conditions at High-frequency *3		Capacitor's Ambient Temp. *2
		Applied Voltage (max.)	Self-heating Temp. (25 °C Ambient Temp.) *1	
R	250V	250Vp-p	10 °C max.	-25 to +85 °C
C	500V	500Vp-p	20 °C max.	
R	1kV	800Vp-p	20 °C max.	
		1000Vp-p	5 °C max.	
	2kV	1400Vp-p	20 °C max.	
		2000Vp-p	5 °C max.	
	3.15kV	1600Vp-p	20 °C max.	
		3150Vp-p	5 °C max.	

*1 Fig. 1 shows the relationship between the applied voltage and the allowable self-heating temperature regarding 1 to 3.15kV rated voltage of the DEH series R characteristic.

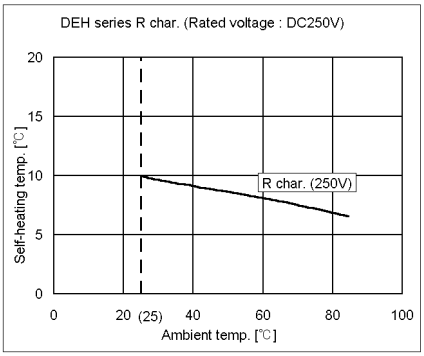
*2 When the ambient temperature is 85 to 125 °C, the applied voltage needs to be further reduced. If the low-dissipation capacitors needs to be used at an ambient temperature of 85 to 125 °C, please contact our sales representatives or product engineers.

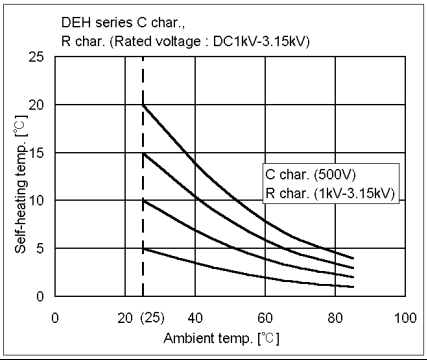
*3 Fig. 3 shows reference data on the allowable voltage-frequency characteristic for a sine wave voltage.

<Fig. 1> Relationship Between Applied Voltage and Self-heating Temperature [Allowable Self-heating Temp. at 25 °C Ambient Temp.]



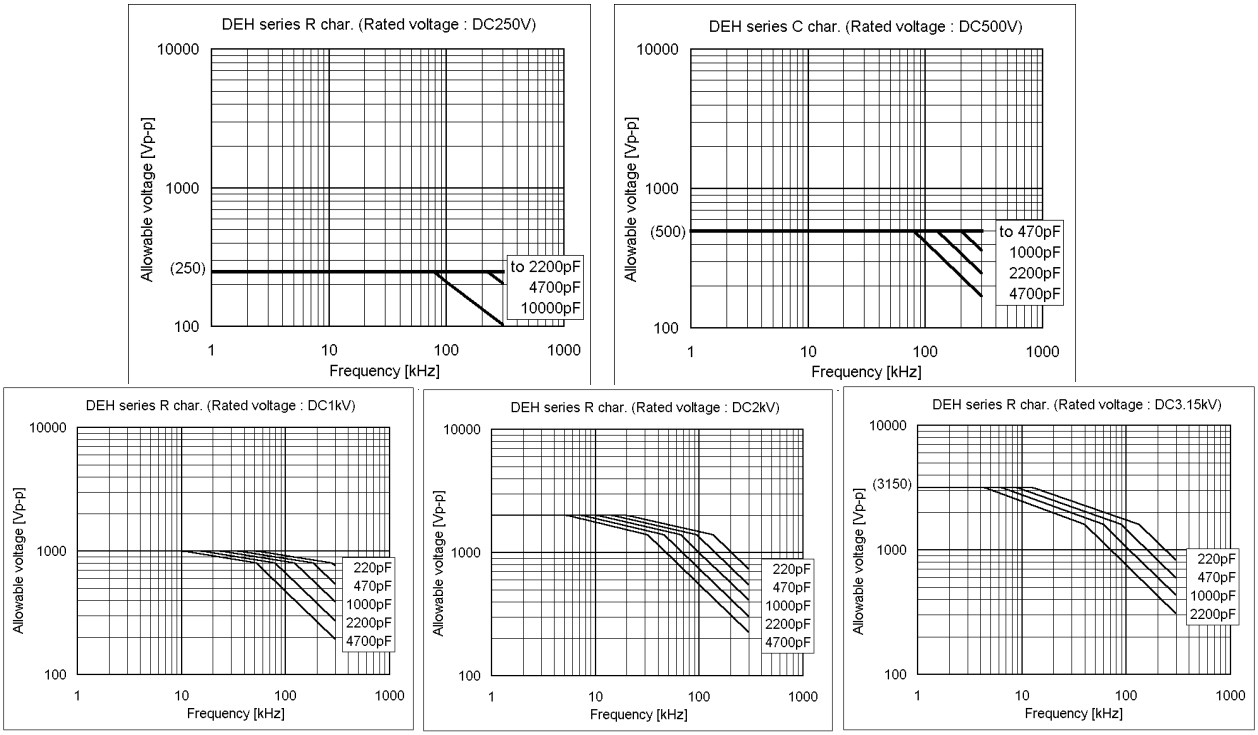
<Fig. 2> Dependence of Self-heating Temperature on Ambient Temperature





<Fig. 3> Allowable Voltage (Sine Wave Voltage) – Frequency Characteristic [At Ambient Temperature of 85 °C or less]

Because of the influence of harmonics, when the applied voltage is a rectangular wave or pulse wave voltage (instead of a sine wave voltage), the heat generated by the capacitor is higher than the value obtained by application of the sine wave with the same fundamental frequency. Roughly calculated for reference, the allowable voltage for a rectangular wave or pulse wave corresponds approximately to the allowable voltage for a sine wave whose fundamental frequency is twice as large as that of the rectangular wave or pulse wave. This allowable voltage, however, varies depending on the voltage and current waveforms. Therefore, you are requested to make sure that the self-heating temperature is not higher than the value specified in Table 1.



5. VIBRATION AND IMPACT

Do not expose a capacitor or its leads to excessive shock or vibration during use.

6. SOLDERING

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification of the capacitor. Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element.

When soldering capacitor with a soldering iron, it should be performed in following conditions.

Temperature of iron tip : 400 °C max.
Soldering iron wattage : 50W max.
Soldering time : 3.5 s max.

7. BONDING, RESIN MOLDING AND COATING

In case of bonding, molding or coating this product, verify that these processes do not affect the quality of capacitor by testing the performance of the bonded, molded or coated product in the intended equipment.

In case of the amount of applications, dryness / hardening conditions of adhesives and molding resins containing organic solvents (ethyl acetate, methyl ethyl ketone, toluene, etc.) are unsuitable, the outer coating resin of a capacitor is damaged by the organic solvents and it may result, worst case, in a short circuit.

The variation in thickness of adhesive, molding resin or coating may cause a outer coating resin cracking and/or ceramic element cracking of a capacitor in a temperature cycling.

8. TREATMENT AFTER BONDING, RESIN MOLDING AND COATING

When the outer coating is hot (over 100 ℃) after soldering, it becomes soft and fragile. So please be careful not to give it mechanical stress.

Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used.

9. OPERATING AND STORAGE ENVIRONMENT

The insulating coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. And avoid exposure to moisture. Before cleaning, bonding, or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment. Store the capacitors where the temperature and relative humidity do not exceed -10 to 40 °C and 15 to 85%. Use capacitors within 6 months after delivered. Check the solderability after 6 months or more.

10. LIMITATION OF APPLICATIONS

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

1. Aircraft equipment
2. Aerospace equipment
3. Undersea equipment
4. Power plant control equipment
5. Medical equipment
6. Transportation equipment (vehicles, trains, ships, etc.)
7. Traffic signal equipment
8. Disaster prevention / crime prevention equipment
9. Data-processing equipment exerting influence on public
10. Application of similar complexity and/or reliability requirements to the applications listed in the above.

NOTICE

1. CLEANING (ULTRASONIC CLEANING)

To perform ultrasonic cleaning, observe the following conditions.
Rinse bath capacity : Output of 20 watts per liter or less.
Rinsing time : 5 min maximum.
Do not vibrate the PCB/PWB directly.
Excessive ultrasonic cleaning may lead to fatigue destruction of the lead wires.

2. CAPACITANCE CHANGE OF CAPACITORS

- Class 1 capacitors
  Capacitance might change a little depending on a surrounding temperature or an applied voltage. Please contact us if you use for the strict time constant circuit.
- Class 2 and 3 capacitors
  Class 2 and 3 capacitors like temperature characteristic B, E and F have an aging characteristic, whereby the capacitor continually decreases its capacitance slightly if the capacitor leaves for a long time. Moreover, capacitance might change greatly depending on a surrounding temperature or an applied voltage. So, it is not likely to be able to use for the time constant circuit.
  Please contact us if you need a detail information.

⚠ NOTE

1.Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
2.You are requested not to use our product deviating from this specification.

1. Application

This specification is applied to High Temperature Low Loss Lead Type Disc Ceramic Capacitors of Class 2 of DEH series used for General Electric equipment.
Do not use these products in any automotive power train or safety equipment including battery chargers for electric vehicles and plug-in hybrids.

2. Rating

2-1. Operating temperature range

-25 ~ +125°C

2-2. Part number configuration

ex.)	DEH	R3	3A	472	K	B3	B	
	Series	Temperature characteristic	Rated voltage	Capacitance	Capacitance tolerance	Lead code	Packing style code	Individual specification

- Temperature characteristic

Code	Temperature characteristic
R3	R
C3	C

Please confirm detailed specification on [Specification and test methods].

- Rated voltage

Code	Rated voltage
2H	DC500V
3A	DC1kV

- Capacitance

The first two digits denote significant figures ; the last digit denotes the multiplier of 10 in pF.
ex.) In case of 472.

$47 \times 10^2 = 4700pF$

- Capacitance tolerance

Please refer to [Part number list].

- Lead code

Code	Lead style
A*	Vertical crimp long type
B*	Vertical crimp short type
N*	Vertical crimp taping type

* Please refer to [Part number list].

Solder coated copper wire is applied for termination.

- Packing style code

Code	Packing type
B	Bulk type
A	Ammo pack taping type

- Individual specification

In case part number cannot be identified without ‘individual specification’ , it is added at the end of part number.

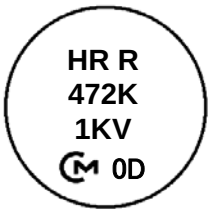
3. Marking

High temperature guaranteed code : HR
Temperature characteristic : Letter code (Omitted for maximum body diameter ϕ 6mm and under of char. C)
Nominal capacitance : 3 digit system
Capacitance tolerance : Code(Omitted for maximum body diameter ϕ 6mm and under)
Rated voltage : Letter code (Omitted for the rated voltage DC500V.)
Company name code : Abbreviation
(Omitted for maximum body diameter ϕ 9mm and under)
Manufacturing year : Letter code(The last digit of A.D. year.)
Manufacturing month : Code

ex.) YEAR MONTH
2010 12(December)
0D*

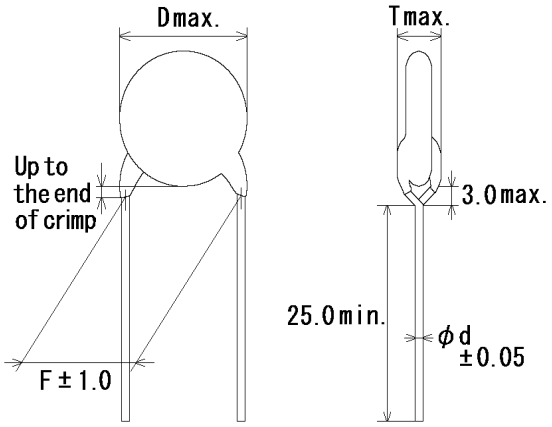
* From January to September : “1” to “9”,
October : “O” , November : “N” , December : “D”

(Example)

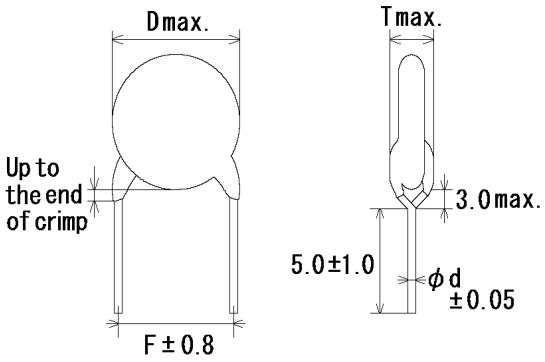


4. Part number list

・Vertical crimp long type
(Lead code:A*)



・Vertical crimp short type
(Lead code:B*)

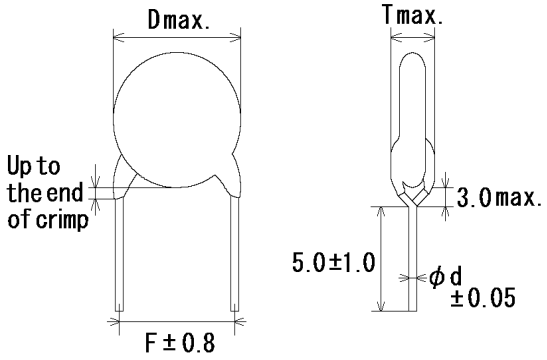


Note) The mark '*' of lead code differ from lead spacing(F) and lead diameter(d).
Please see the following list about details.

Unit : mm

T.C.	Cap. (pF)	Cap. tol.	Customer Part Number	Murata Part Number	DC Rated Volt. (V)	Dimension (mm)				Lead Code	Pack qty. (pcs)
						D	T	F	d		
C	330	±10%		DEHC32H331KA2B	500	6.0	4.0	5.0	0.6	A2	500
C	470	±10%		DEHC32H471KA2B	500	6.0	4.0	5.0	0.6	A2	500
C	680	±10%		DEHC32H681KA2B	500	7.0	4.0	5.0	0.6	A2	500
C	1000	±10%		DEHC32H102KA2B	500	8.0	4.0	5.0	0.6	A2	250
C	1500	±10%		DEHC32H152KA2B	500	9.0	4.0	5.0	0.6	A2	250
C	2200	±10%		DEHC32H222KA2B	500	10.0	4.0	5.0	0.6	A2	250
C	3300	±10%		DEHC32H332KA2B	500	12.0	4.0	5.0	0.6	A2	250
C	4700	±10%		DEHC32H472KA4B	500	14.0	4.0	10.0	0.6	A4	200
R	220	±10%		DEHR33A221KA2B	1000	7.0	4.5	5.0	0.6	A2	500
R	330	±10%		DEHR33A331KA2B	1000	7.0	4.5	5.0	0.6	A2	500
R	470	±10%		DEHR33A471KA2B	1000	7.0	4.5	5.0	0.6	A2	500
R	680	±10%		DEHR33A681KA2B	1000	8.0	4.5	5.0	0.6	A2	250
R	1000	±10%		DEHR33A102KA2B	1000	9.0	4.5	5.0	0.6	A2	250
R	1500	±10%		DEHR33A152KA2B	1000	11.0	4.5	5.0	0.6	A2	250
R	2200	±10%		DEHR33A222KA3B	1000	13.0	4.5	7.5	0.6	A3	200
R	3300	±10%		DEHR33A332KA3B	1000	15.0	4.5	7.5	0.6	A3	100
R	4700	±10%		DEHR33A472KA3B	1000	17.0	4.5	7.5	0.6	A3	100
C	330	±10%		DEHC32H331KB2B	500	6.0	4.0	5.0	0.6	B2	500
C	470	±10%		DEHC32H471KB2B	500	6.0	4.0	5.0	0.6	B2	500
C	680	±10%		DEHC32H681KB2B	500	7.0	4.0	5.0	0.6	B2	500
C	1000	±10%		DEHC32H102KB2B	500	8.0	4.0	5.0	0.6	B2	500
C	1500	±10%		DEHC32H152KB2B	500	9.0	4.0	5.0	0.6	B2	500
C	2200	±10%		DEHC32H222KB2B	500	10.0	4.0	5.0	0.6	B2	500
C	3300	±10%		DEHC32H332KB2B	500	12.0	4.0	5.0	0.6	B2	500
C	4700	±10%		DEHC32H472KB4B	500	14.0	4.0	10.0	0.6	B4	250
R	220	±10%		DEHR33A221KB2B	1000	7.0	4.5	5.0	0.6	B2	500
R	330	±10%		DEHR33A331KB2B	1000	7.0	4.5	5.0	0.6	B2	500

·Vertical crimp short type
(Lead code:B*)

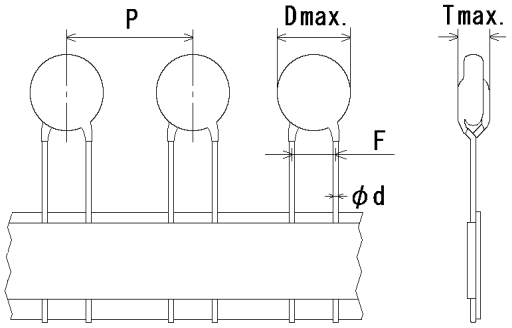


Note) The mark '*' of lead code differ from lead spacing(F) and lead diameter(d).
Please see the following list about details.

Unit : mm

T.C.	Cap. (pF)	Cap. tol.	Customer Part Number	Murata Part Number	DC Rated Volt. (V)	Dimension (mm)				Lead Code	Pack qty. (pcs)
						D	T	F	d		
R	470	±10%		DEHR33A471KB2B	1000	7.0	4.5	5.0	0.6	B2	500
R	680	±10%		DEHR33A681KB2B	1000	8.0	4.5	5.0	0.6	B2	500
R	1000	±10%		DEHR33A102KB2B	1000	9.0	4.5	5.0	0.6	B2	500
R	1500	±10%		DEHR33A152KB2B	1000	11.0	4.5	5.0	0.6	B2	500
R	2200	±10%		DEHR33A222KB3B	1000	13.0	4.5	7.5	0.6	B3	250
R	3300	±10%		DEHR33A332KB3B	1000	15.0	4.5	7.5	0.6	B3	200
R	4700	±10%		DEHR33A472KB3B	1000	17.0	4.5	7.5	0.6	B3	200

·Vartical crimp taping type
(Lead code:N*)

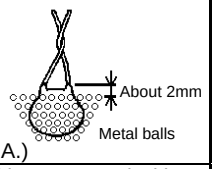
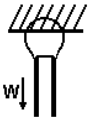


Note) The mark '*' of lead code differ from lead spacing(F), lead diameter(d) and pitch of component(P). Please see the following list or taping specification about details.

Unit : mm

T.C.	Cap. (pF)	Cap. tol.	Customer Part Number	Murata Part Number	DC Rated volt. (V)	Dimension (mm)					Lead code	Pack qty. (pcs)
						D	T	F	d	P		
C	330	±10%		DEHC32H331KN2A	500	6.0	4.0	5.0	0.6	12.7	N2	1500
C	470	±10%		DEHC32H471KN2A	500	6.0	4.0	5.0	0.6	12.7	N2	1500
C	680	±10%		DEHC32H681KN2A	500	7.0	4.0	5.0	0.6	12.7	N2	1500
C	1000	±10%		DEHC32H102KN2A	500	8.0	4.0	5.0	0.6	12.7	N2	1500
C	1500	±10%		DEHC32H152KN2A	500	9.0	4.0	5.0	0.6	12.7	N2	1500
C	2200	±10%		DEHC32H222KN2A	500	10.0	4.0	5.0	0.6	12.7	N2	1500
C	3300	±10%		DEHC32H332KN2A	500	12.0	4.0	5.0	0.6	12.7	N2	1500
R	220	±10%		DEHR33A221KN2A	1000	7.0	4.5	5.0	0.6	12.7	N2	1500
R	330	±10%		DEHR33A331KN2A	1000	7.0	4.5	5.0	0.6	12.7	N2	1500
R	470	±10%		DEHR33A471KN2A	1000	7.0	4.5	5.0	0.6	12.7	N2	1500
R	680	±10%		DEHR33A681KN2A	1000	8.0	4.5	5.0	0.6	12.7	N2	1500
R	1000	±10%		DEHR33A102KN2A	1000	9.0	4.5	5.0	0.6	12.7	N2	1500
R	1500	±10%		DEHR33A152KN2A	1000	11.0	4.5	5.0	0.6	12.7	N2	1500
R	2200	±10%		DEHR33A222KN3A	1000	13.0	4.5	7.5	0.6	15.0	N3	1000
R	3300	±10%		DEHR33A332KN7A	1000	15.0	4.5	7.5	0.6	30.0	N7	500
R	4700	±10%		DEHR33A472KN7A	1000	17.0	4.5	7.5	0.6	30.0	N7	500

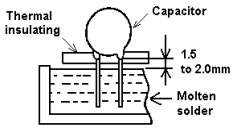
5. Specification and test methods

No.	Item		Specification	Test method
1	Appearance and dimensions		No marked defect on appearance form and dimensions. Please refer to [Part number list].	The capacitor should be inspected by naked eyes for visible evidence of defect. Dimensions should be measured with slide calipers.
2	Marking		To be easily legible.	The capacitor should be inspected by naked eyes.
3	Dielectric strength	Between lead wires	No failure.	The capacitor should not be damaged when DC voltage of 200% of the rated voltage (In case of rated voltage: DC1kV) or DC voltage of 250% of the rated voltage (In case of rated voltage: DC500V) are applied between the lead wires for 1 to 5 s. (Charge/Discharge current≤50mA.)
		Body insulation	No failure.	The capacitor is placed in the container with metal balls of diameter 1mm so that each lead wire, shortcircuited, is kept about 2mm off the balls as shown in the figure, and AC1 250V (r.m.s.)<50/60Hz> is applied for 1 to 5 s between capacitor lead wires and small metals. (Charge/Discharge current≤50mA.) 
4	Insulation Resistance (I.R.)	Between lead wires	10000MΩ min.	The insulation resistance should be measured with DC500±50V within 60±5 s of charging.
5	Capacitance		Within specified tolerance.	The capacitance should be measured at 20°C with 1±0.2kHz and AC5V(r.m.s.) max..
6	Dissipation Factor (D.F.)		Char. R : 0.2% max. Char. C : 0.3% max.	The dissipation factor should be measured at 20°C with 1±0.2kHz and AC5V(r.m.s.) max..
7	Temperature characteristic		<table><tr><td rowspan="2">T.C.</td><td colspan="2">Temp. char.</td></tr><tr><td>-25 to +85°C</td><td>+85 to +125°C</td></tr><tr><td>R</td><td>Within ±15%</td><td rowspan="2">Within +15/-30%</td></tr><tr><td>C</td><td>Within ±20%</td></tr></table>	The capacitance measurement should be made at each step specified in Table. Pre-treatment : Capacitor should be stored at 125±3°C for 1 h, then placed at *1room condition for 24±2 h before initial measurements.
8	Strength of lead	Pull	Lead wire should not cut off. Capacitor should not be broken.	As shown in the figure at right, fix the body of the capacitor and apply a tensile weight gradually to each lead wire in the radial direction of the capacitor up to 10N,and keep it for 10±1 s. 
		Bending		Each lead wire should be subjected to 5N of weight and bent 90° at the point of egress, in one direction, then returned to its original position, and bent 90° in the opposite direction at the rate of one bend in 2 to 3 s.

Step	1	2	3	4	5
Temp.(°C)	20±2	-25±3	20±2	125±2	20±2

*1 "room condition" Temperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmospheric pressure: 86 to 106kPa

Reference only

No.	Item		Specification	Test method
9	Vibration resistance	Appearance	No marked defect.	The capacitor should be firmly soldered to the supporting lead wire and vibrated at a frequency range of 10 to 55Hz, 1.5mm in total amplitude, with about a 1min rate of vibration change from 10Hz to 55Hz and back to 10Hz. Apply for a total of 6 h; 2 h each in 3 mutually perpendicular directions.
		Capacitance	Within specified tolerance.	
		D.F.	Char. R : 0.2% max. Char. C : 0.3% max.	
10	Solderability of leads		Lead wire should be soldered with uniformly coated on the axial direction over 3/4 of the circumferential direction.	The lead wire of a capacitor should be dipped into a ethanol solution of 25wt% rosin and then into molten solder for 2±0.5 s. In both cases the depth of dipping is up to about 1.5 to 2mm from the root of lead wires. Temp. of solder : 245±5°C Lead Free Solder (Sn-3Ag-0.5Cu) 235±5°C H63 Eutectic Solder
11	Soldering effect (Non-preheat)	Appearance	No marked defect.	The lead wire should be immersed into the melted solder of 350±10°C up to about 1.5 to 2.0mm from the main body for 3.5±0.5 s. Pre-treatment : Capacitor should be stored at 125±3°C for 1 h, then placed at *1room condition for 24±2 h before initial measurements. Post-treatment : Capacitor should be stored for 24±2 h at *1room condition.
		Capacitance change	Within ± 10%	
		Dielectric strength (Between lead wires)	Per item 3.	
12	Soldering effect (On-preheat)	Appearance	No marked defect.	First the capacitor should be stored at 120+0/-5°C for 60+0/-5 s. Then, as in figure, the lead wires should be immersed solder of 260+0/-5°C up to 1.5 to 2.0mm from the root of terminal for 7.5+0/-1 s.  Pre-treatment : Capacitor should be stored at 125±3°C for 1 h, then placed at *1room condition for 24±2 h before initial measurements. Post-treatment : Capacitor should be stored for 24±2 h at *1room condition.
		Capacitance change	Within ± 10%	
		Dielectric strength (Between lead wires)	Per item 3.	
13	Humidity (Under steady state)	Appearance	No marked defect.	Set the capacitor for 500 +24/-0 h at 40±2°C in 90 to 95% relative humidity. Pre-treatment : Capacitor should be stored at 125±3°C for 1 h, then placed at *1room condition for 24±2 h before initial measurements. Post-treatment : Capacitor should be stored for 1 to 2 h at *1room condition.
		Capacitance change	Within ±10%	
		D.F.	0.4% max.	
		I.R.	1000MΩ min.	

*1 "room condition" Temperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmospheric pressure: 86 to 106kPa

Reference only

<table>
<tr><th>No.</th><th colspan="2">Item</th><th>Specification</th><th>Test method</th></tr>
<tr><td rowspan="4">14</td><td rowspan="4">Humidity loading</td><td>Appearance</td><td>No marked defect.</td><td rowspan="4">Apply the rated voltage for 500 +24/-0 h at 40±2°C in 90 to 95% relative humidity.
(Charge/Discharge current≤50mA.)
Pre-treatment :
Capacitor should be stored at 125±3°C for 1 h, then placed at *1room condition for 24±2 h before initial measurements.
Post-treatment :
Capacitor should be stored for 1 to 2 h at *1room condition.</td></tr>
<tr><td>Capacitance change</td><td>Within ±10%</td></tr>
<tr><td>D.F.</td><td>0.6% max.</td></tr>
<tr><td>I.R.</td><td>1000MΩ min.</td></tr>
<tr><td rowspan="4">15</td><td rowspan="4">Life</td><td>Appearance</td><td>No marked defect.</td><td rowspan="4">Apply a DC voltage of 200% of the rated voltage (In case of rated voltage:DC500V) or DC voltage of 150% of the rated voltage (In case of rated voltage:DC1kV) for 1000 +48/-0 h at 125±2°C and relative humidity of 50% max..
(Charge/Discharge current≤50mA.)
Pre-treatment :
Capacitor should be stored at 125±3°C for 1 h, then placed at *1room condition for 24±2 h before initial measurements.
Post-treatment :
Capacitor should be stored at 125±3°C for 1 h, then placed at *1room condition for 24±2 h.</td></tr>
<tr><td>Capacitance change</td><td>Within ±10%</td></tr>
<tr><td>D.F.</td><td>0.4% max.</td></tr>
<tr><td>I.R.</td><td>2000MΩ min.</td></tr>
<tr><td rowspan="5">16</td><td rowspan="5">Temperature cycle</td><td>Appearance</td><td>No marked defect.</td><td rowspan="5">The capacitor should be subjected to 5 temperature cycles.
<Temperature cycle>
<table><tr><th>Step</th><th>Temperature(°C)</th><th>Time</th></tr><tr><td>1</td><td>-25±3</td><td>30 min</td></tr><tr><td>2</td><td>Room Temp.</td><td>3 min</td></tr><tr><td>3</td><td>+125±3</td><td>30 min</td></tr><tr><td>4</td><td>Room Temp.</td><td>3 min</td></tr></table>Cycle time : 5 cycle
Pre-treatment :
Capacitor should be stored at 125±3°C for 1 h, then placed at *1room condition for 24±2 h before initial measurements.
Post-treatment :
Capacitor should be stored for 24±2 h at *1room condition.</td></tr>
<tr><td>Capacitance change</td><td>Within ±10%</td></tr>
<tr><td>D.F.</td><td>0.4% max.</td></tr>
<tr><td>I.R.</td><td>1000MΩ min.</td></tr>
<tr><td>Dielectric strength (Between lead wires)</td><td>Per item 3.</td></tr>
</table>

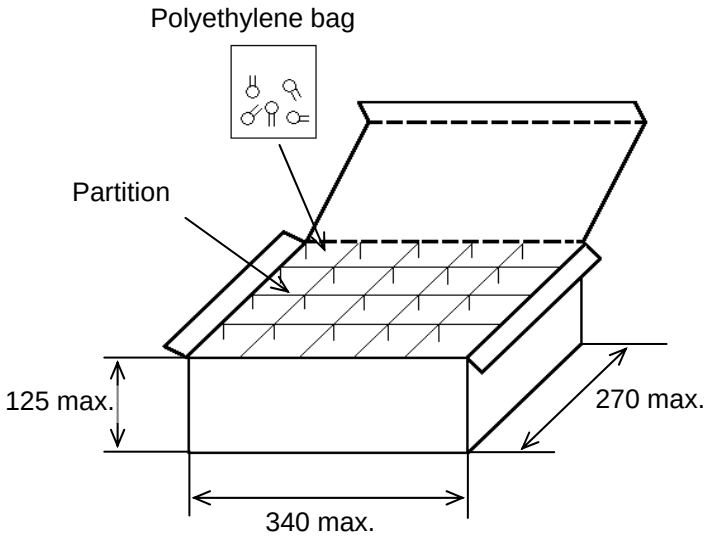
*1 "room condition" Temperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmospheric pressure: 86 to 106kPa

6.Packing specification

•Bulk type (Packing style code : B)

The number of packing = $\overset{*1}{\text{Packing quantity}} \times \overset{*2}{n}$

The size of packing case and packing way



Unit : mm

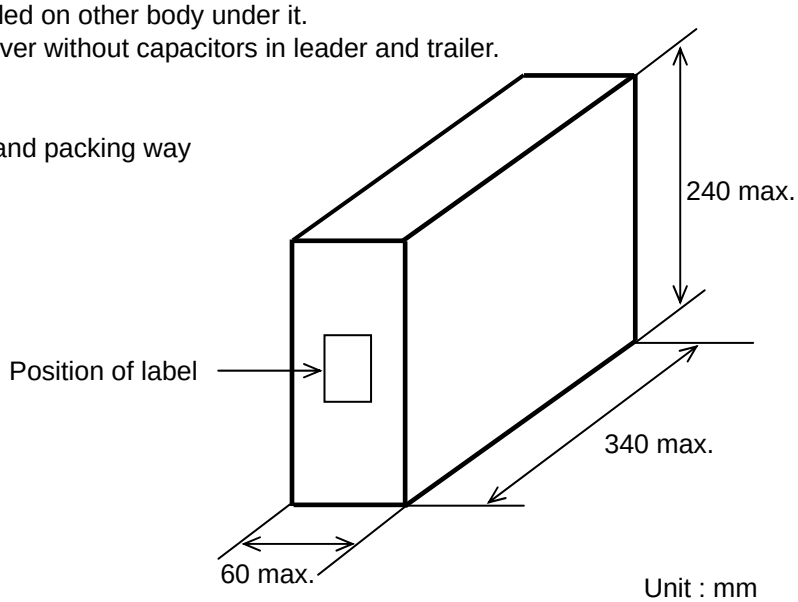
∗1 : Please refer to [Part number list].
∗2 : Standard n = 20 (bag)

Note)
The outer package and the number of outer packing be changed by the order getting amount.

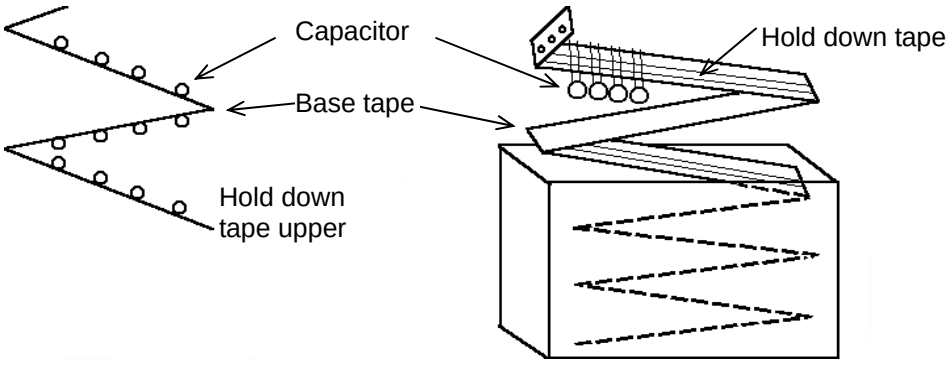
•Ammo pack taping type (Packing style code : A)

· The tape with capacitors is packed zigzag into a case.
· When body of the capacitor is piled on other body under it.
· There should be 3 pitches and over without capacitors in leader and trailer.

The size of packing case and packing way



Unit : mm

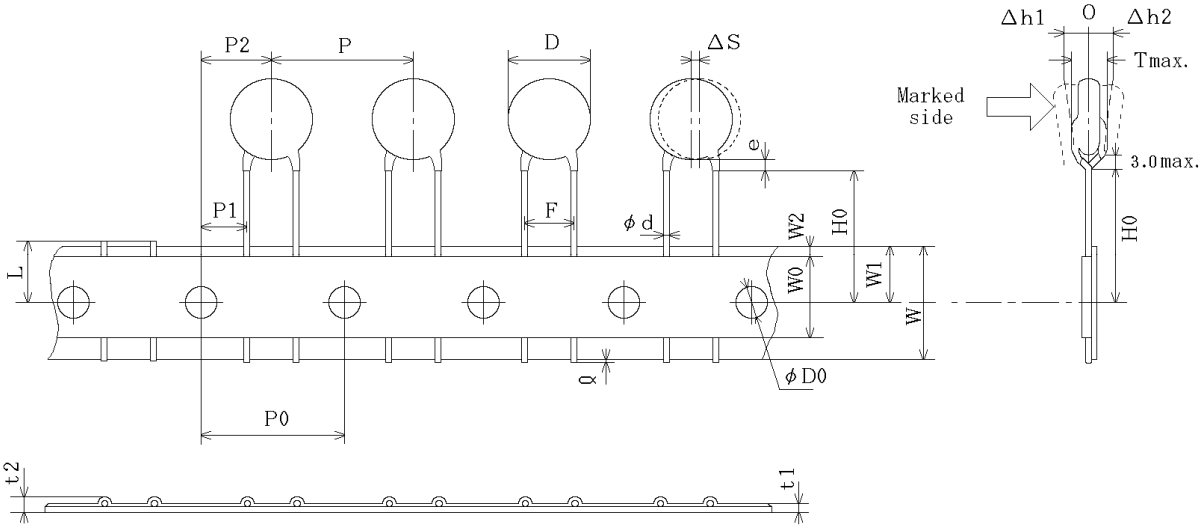


7. Taping specification

7-1. Dimension of capacitors on tape

Vertical crimp taping type < Lead code : N2 >

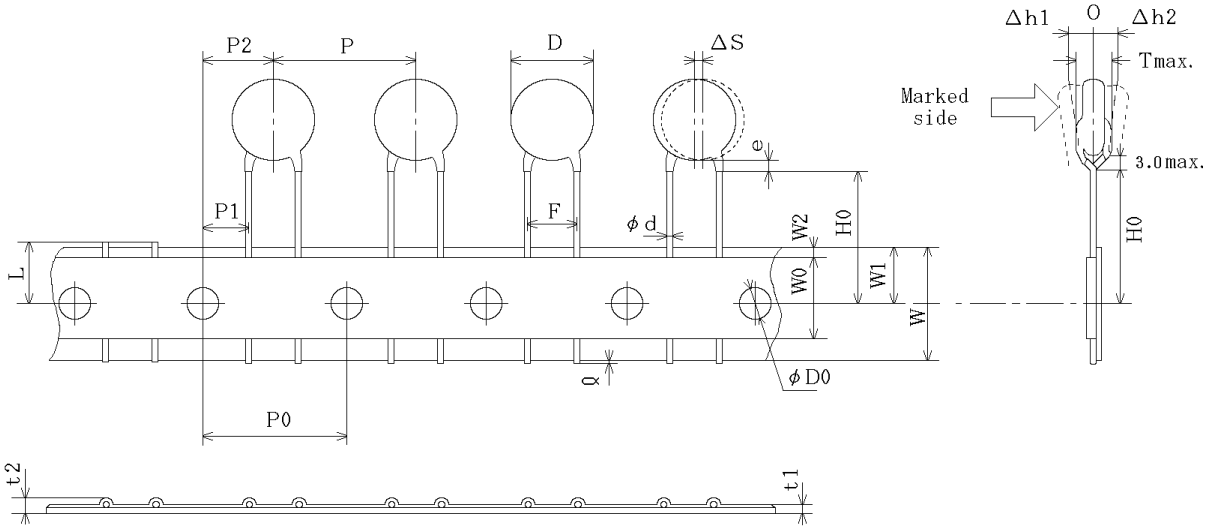
Pitch of component 12.7mm / Lead spacing 5.0mm



Unit : mm

Item	Code	Dimensions	Remarks
Pitch of component	P	12.7±1.0	
Pitch of sprocket hole	P0	12.7±0.3	
Lead spacing	F	$5.0^{+0.8}_{-0.2}$	
Length from hole center to component center	P2	6.35±1.3	Deviation of progress direction
Length from hole center to lead	P1	3.85±0.7	
Body diameter	D	Please refer to [Part number list].	
Deviation along tape, left or right	ΔS	0±1.0	They include deviation by lead bend .
Carrier tape width	W	18.0±0.5	
Position of sprocket hole	W1	9.0±0.5	Deviation of tape width direction
Lead distance between reference and bottom planes	H0	$18.0^{+2.0}_{0}$	
Protrusion length	Q	+0.5~−1.0	
Diameter of sprocket hole	φD0	4.0±0.1	
Lead diameter	φd	0.60±0.05	
Total tape thickness	t1	0.6±0.3	They include hold down tape thickness.
Total thickness, tape and lead wire	t2	1.5 max.	
Deviation across tape, front	Δh1	1.0 max.	
Deviation across tape, rear	Δh2		
Portion to cut in case of defect	L	$11.0^{+0}_{-1.0}$	
Hold down tape width	W0	11.5 min.	
Hold down tape position	W2	1.5±1.5	
Coating extension on lead	e	Up to the end of crimp	
Body thickness	T	Please refer to [Part number list].	

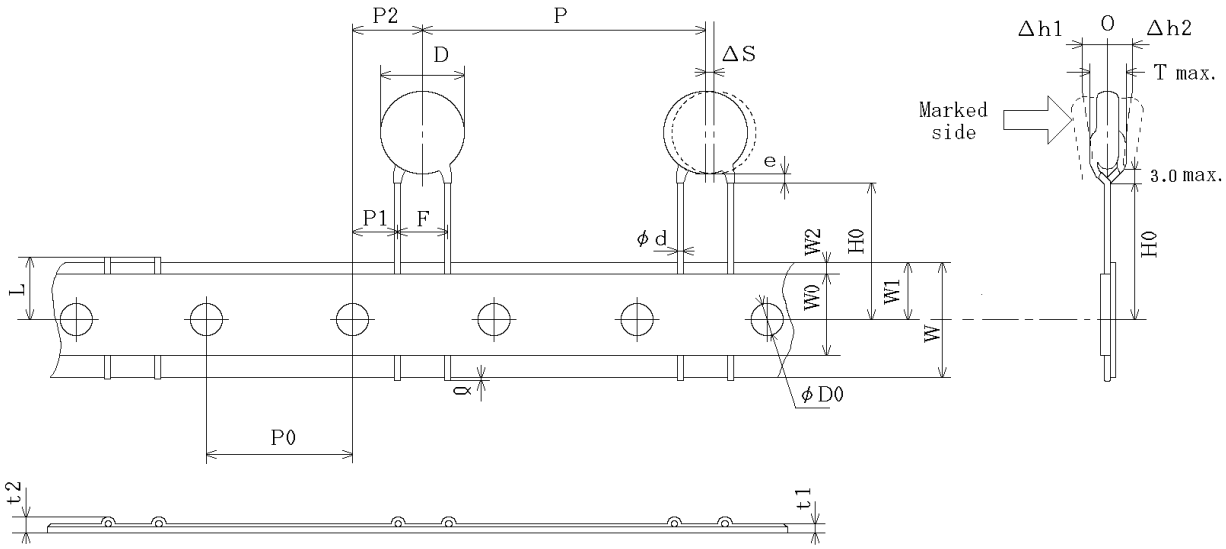
Vertical crimp taping type < Lead code : N3 >
Pitch of component 15.0mm / Lead spacing 7.5mm



Unit : mm

Item	Code	Dimensions	Remarks
Pitch of component	P	15.0±2.0	
Pitch of sprocket hole	P0	15.0±0.3	
Lead spacing	F	7.5±1.0	
Length from hole center to component center	P2	7.5±1.5	Deviation of progress direction
Length from hole center to lead	P1	3.75±1.0	
Body diameter	D	Please refer to [Part number list].	
Deviation along tape, left or right	ΔS	0±2.0	They include deviation by lead bend .
Carrier tape width	W	18.0±0.5	
Position of sprocket hole	W1	9.0±0.5	Deviation of tape width direction
Lead distance between reference and bottom planes	H0	$18.0\pm^{2.0}_{0}$	
Protrusion length	ℓ	+0.5~−1.0	
Diameter of sprocket hole	φD0	4.0±0.1	
Lead diameter	φd	0.60±0.05	
Total tape thickness	t1	0.6±0.3	They include hold down tape thickness.
Total thickness, tape and lead wire	t2	1.5 max.	
Deviation across tape, front	Δh1	2.0 max.	
Deviation across tape, rear	Δh2		
Portion to cut in case of defect	L	$11.0\pm^{0}_{1.0}$	
Hold down tape width	W0	11.5 min.	
Hold down tape position	W2	1.5±1.5	
Coating extension on lead	e	Up to the end of crimp	
Body thickness	T	Please refer to [Part number list].	

Vertical crimp taping type < Lead code : N7 >
Pitch of component 30.0mm /Lead spacing 7.5mm

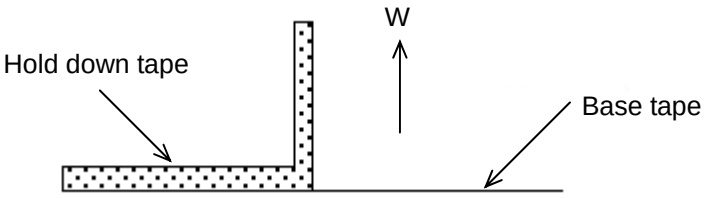


Unit : mm

Item	Code	Dimensions	Remarks
Pitch of component	P	30.0±2.0	
Pitch of sprocket hole	P0	15.0±0.3	
Lead spacing	F	7.5±1.0	
Length from hole center to component center	P2	7.5±1.5	Deviation of progress direction
Length from hole center to lead	P1	3.75±1.0	
Body diameter	D	Please refer to [Part number list].	
Deviation along tape, left or right	ΔS	0±2.0	They include deviation by lead bend.
Carrier tape width	W	18.0±0.5	
Position of sprocket hole	W1	9.0±0.5	Deviation of tape width direction
Lead distance between reference and bottom planes	H0	$18.0\pm^{2.0}_{0}$	
Protrusion length	ℚ	+0.5~−1.0	
Diameter of sprocket hole	ϕD0	4.0±0.1	
Lead diameter	ϕd	0.60±0.05	
Total tape thickness	t1	0.6±0.3	They include hold down tape thickness.
Total thickness, tape and lead wire	t2	1.5 max.	
Deviation across tape, front	Δh1	2.0 max.	
Deviation across tape, rear	Δh2		
Portion to cut in case of defect	L	$11.0\pm^{0}_{1.0}$	
Hold down tape width	W0	11.5 min.	
Hold down tape position	W2	1.5±1.5	
Coating extension on lead	e	Up to the end of crimp	
Body thickness	T	Please refer to [Part number list].	

7-2. Splicing way of tape

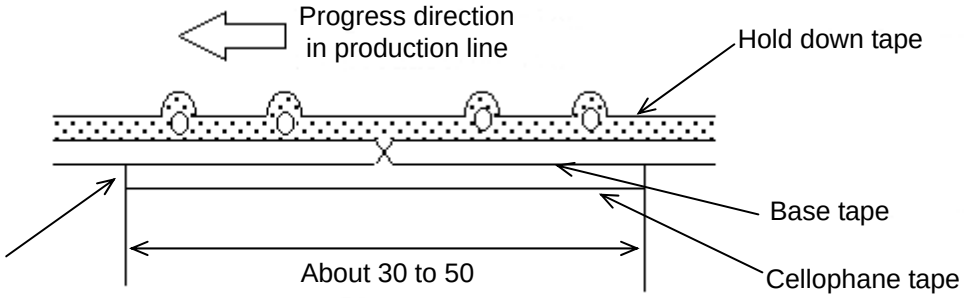
1) Adhesive force of tape is over 3N at test condition as below.



2) Splicing of tape

a) When base tape is spliced

- Base tape should be spliced by cellophane tape.
  (Total tape thickness should be less than 1.05mm.)

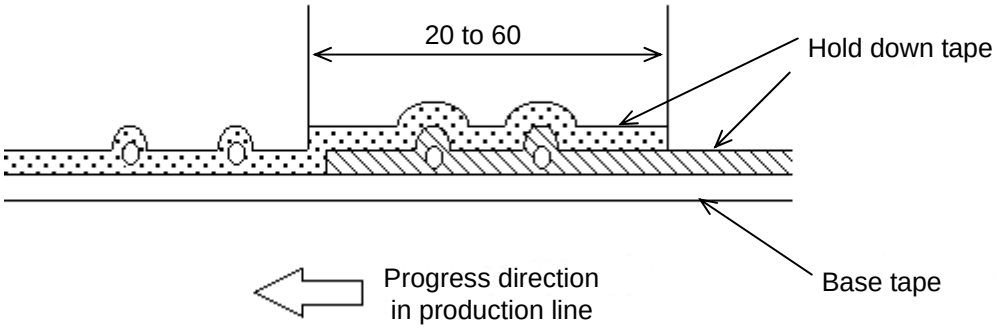


No lifting for the direction of progressing

Unit : mm

b) When hold down tape is spliced

- Hold down tape should be spliced with overlapping.
  (Total tape thickness should be less than 1.05mm.)



Unit : mm

c) When both tape are spliced

- Base tape and hold down tape should be spliced with splicing tape.

3) Missing components

- There should be no consecutive missing of more than three components.
- The number of missing components should be not more than 0.5% of total components that should be present in a Ammo pack.

Appendix
添付資料

EU RoHS
RoHS指令への対応

This products of the following crresponds to EU RoHS
当製品は以下の欧州RoHSに対応しています。

(1) RoHS

EU RoHs 2011/65/EC compliance
2011/65/EC（改正RoHS指令）に対応

maximum concentration values tolerated by weight in homogeneous materials
・1000 ppm maximum Lead
・1000 ppm maximum Mercury
・100 ppm maximum Cadmium
・1000 ppm maximum Hexavalent chromium
・1000 ppm maximum Polybrominated biphenyls (PBB)
・1000 ppm maximum Polybrominated diphenyl ethers (PBDE)

鉛：1000ppm以下
水銀：1000ppm以下
カドミウム：100ppm以下
六価クロム：1000ppm以下
ポリ臭化ビフェニル(PBB)：1000ppm以下
ポリ臭化ジフェニルエーテル(PBDE)：1000ppm以下

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